TOSHIBA Field Effect Transistor Silicon N-Channel MOS Type (U-MOS VI-H)

TPCA8047-H

Switching Regulator Applications Motor Drive Applications DC-DC Converter Applications

- Small footprint due to a small and thin package
- High-speed switching
- Small gate charge: Q_{SW} = 13 nC (typ.)
- Low drain-source ON-resistance: R_{DS} (ON) = 4.8 $m\Omega$ (typ.)
- High forward transfer admittance: $|Y_{fs}| = 92 S$ (typ.)
- Low leakage current: $I_{DSS} = 10 \mu A (max) (V_{DS} = 40 V)$
- Enhancement mode: $V_{th} = 1.3 \text{ to } 2.3 \text{ V } (V_{DS} = 10 \text{ V}, I_D = 0.5 \text{ mA})$

Absolute Maximum Ratings (Ta = 25°C)

Characteristic		Symbol	Rating	Unit	
Drain-source voltage		V_{DSS}	40	V	
Drain-gate voltage ($R_{GS} = 20 \text{ k}\Omega$)		V _{DGR}	40	V	
Gate-source voltage		V _{GSS}	±20	<\v	
Drain current	DC (Note 1)	ID((32	A	
	Pulsed (Note 1)	IDP	96	^	
Drain power dissipation	on (Tc = 25°C)	(PD	45	//w	
Drain power dissipation	on (t = 10 s) (Note 2a)	PD	2.8	W	
Drain power dissipation	on (t = 10 s) (Note 2b)	PD	1,6	W	
Single-pulse avalanche energy (Note 3)		EAS	95	mJ	
Avalanche current		I _{AR}	32	Α	
Repetitive avalanche energy (Tc = 25°C) (Note 4)		EAR	3.95	mJ	
Channel temperature		T _{ch}	150	°C	
Storage temperature range		T _{stg}	-55 to 150	°C	

Note: For Notes 1 to 4, refer to the next page.

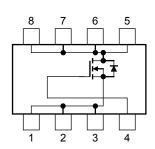
Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the

reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings. Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

This transistor is an electrostatic-sensitive device. Handle with care.

Weight: 0.069 g (typ.)

Circuit Configuration

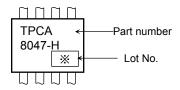


Start of commercial production 2008-10

Thermal Characteristics

Characteristic	Symbol	Max	Unit
Thermal resistance, channel to case (Tc = 25°C)	R _{th (ch-c)}	2.78	°C/W
Thermal resistance, channel to ambient (t = 10 s) (Note 2a)	R _{th (ch-a)}	44.6	°C/W
Thermal resistance, channel to ambient (t = 10 s) (Note 2b)	R _{th (ch-a)}	78.1	°C/W

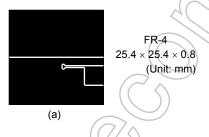
Marking (Note 5)

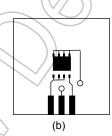


Note 1: Ensure that the channel temperature does not exceed 150°C.

Note 2: (a) Device mounted on a glass-epoxy board (a)

(b) Device mounted on a glass-epoxy board (b)





FR-4 $25.4 \times 25.4 \times 0.8$ (Unit: mm)

Note 3: $V_{DD} = 24 \text{ V}$, $T_{Ch} = 25^{\circ}\text{C}$ (initial), $L = 100 \ \mu\text{H}$, $R_G = 25 \ \Omega$, $I_{AR} = 32 \ \text{A}$

Note 4: Repetitive rating: pulse width limited by maximum channel temperature

Note 5: * Weekly code: (Three digits)

Week of manufacture

(01) for the first week of the year, continuing up to 52 or 53)

Year of manufacture (The last digit of the year)



Electrical Characteristics (Ta = 25°C)

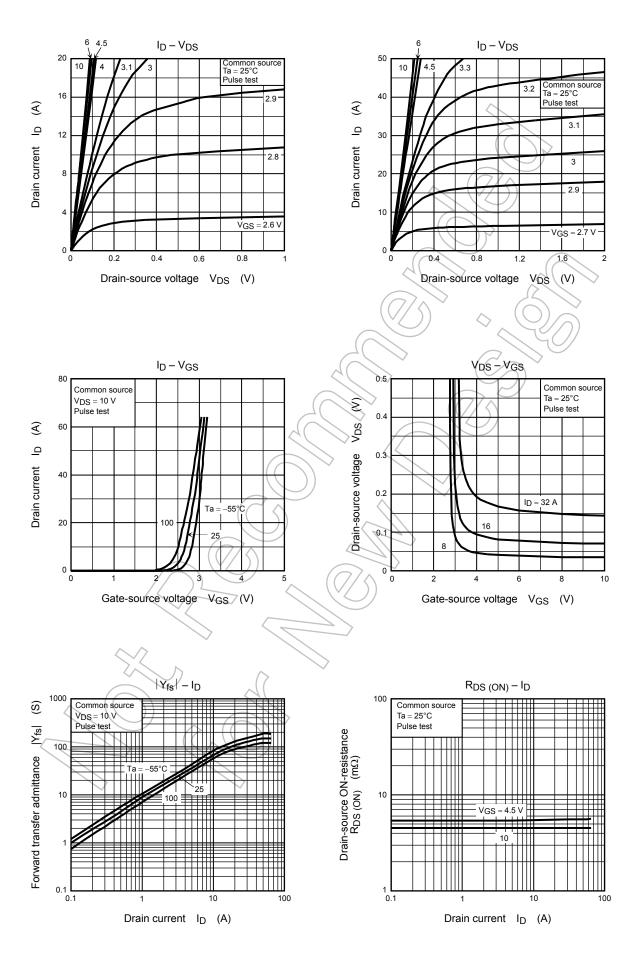
Ch	aracteristic	Symbol	Test Condition	Min	Тур.	Max	Unit
Gate leakage cur	rent	I _{GSS}	$V_{GS} = \pm 20 \text{ V}, V_{DS} = 0 \text{ V}$	_	_	±100	nA
Drain cutoff curre	ent	I _{DSS}	V _{DS} = 40 V, V _{GS} = 0 V		_	10	μА
Drain-source breakdown voltage		V (BR) DSS	I _D = 10 mA, V _{GS} = 0 V	40	_	_	٧
		V (BR) DSX	$I_D = 10 \text{ mA}, V_{GS} = -20 \text{ V}$	25	_	_	
Gate threshold vo	oltage	V _{th}	$V_{DS} = 10 \text{ V}, I_D = 0.5 \text{ mA}$	1.3))^_	2.3	V
Drain-source ON-resistance			V _{GS} = 4.5 V, I _D = 16 A) 	6.0	8.5	- mΩ
		R _{DS} (ON)	V _{GS} = 10 V, I _D = 16 A	\mathcal{D}	4.8	7.3	
Forward transfer	admittance	Y _{fs}	V _{DS} = 10 V, I _D = 16 A	46	92	_	S
Input capacitance		C _{iss}	V _{DS} = 10 V, V _{GS} = 0 V, f = 1 MHz	_	2590	3365	pF
Reverse transfer capacitance		C _{rss}		_	135	200	
Output capacitan	ce	Coss		/	440	\nearrow	
Gate resistance		rg	V _{DS} = 10 V, V _{GS} = 0 V, f = 1 MHz	-6	1.0	1.5	Ω
Switching time	Rise time	t _r	V = 10 V ☐ I _D = 16 A		4.8) —	
	Turn-on time	t _{on}	VGS 10 V ID = 16 A CYOUT	$\sqrt{2}$	13	_	ns
	Fall time	t _f	4 m m o m o m o m o m o m o m o m o m o		9.9		113
	Turn-off time	t _{off}	V _{DD} ≈ 20 V Duty ≤ 1%, t _w = 10 μs	_	43	_	
Total gate charge (gate-source plus gate-drain)		Qg	$V_{DD} \approx 32 \text{ V}, V_{GS} = 10 \text{ V}, I_D = 32 \text{ A}$	_	43	_	
			$V_{DD} \approx 32 \text{ V}, V_{GS} = 5 \text{ V}, I_D = 32 \text{ A}$		23		
Gate-source char	rge 1	Q _{gs1}			7.9		nC
Gate-drain ("Miller") charge		Q_{gd}	$V_{DD} \approx 32 \text{ V}, V_{GS} = 10 \text{ V}, I_D = 32 \text{ A}$		8.4		
Gate switch char	ge (//	Q _{SW}		_	13	_	

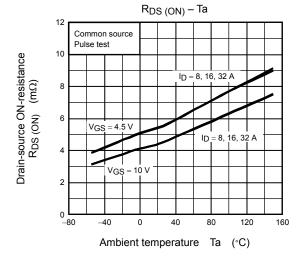
Source-Drain Ratings and Characteristics (Ta = 25°C)

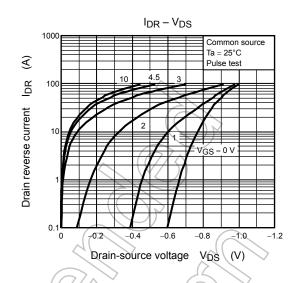
Characteristic	Symbol	Test Condition	Min	Тур.	Max	Unit
Drain reverse current Pulse (Note 1)	I _{DRP}	> -	_	_	96	Α
Forward voltage (diode)	V _{DSF}	$I_{DR} = 32 \text{ A}, V_{GS} = 0 \text{ V}$		_	-1.2	V

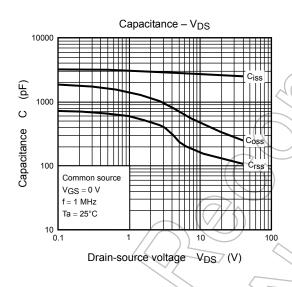
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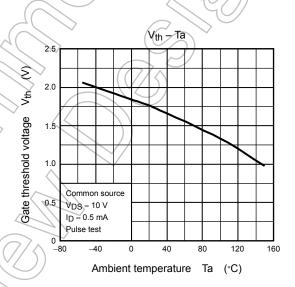
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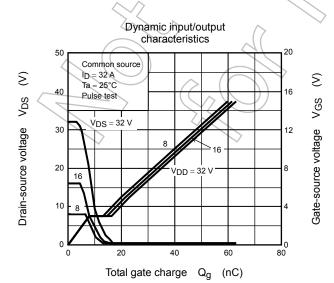




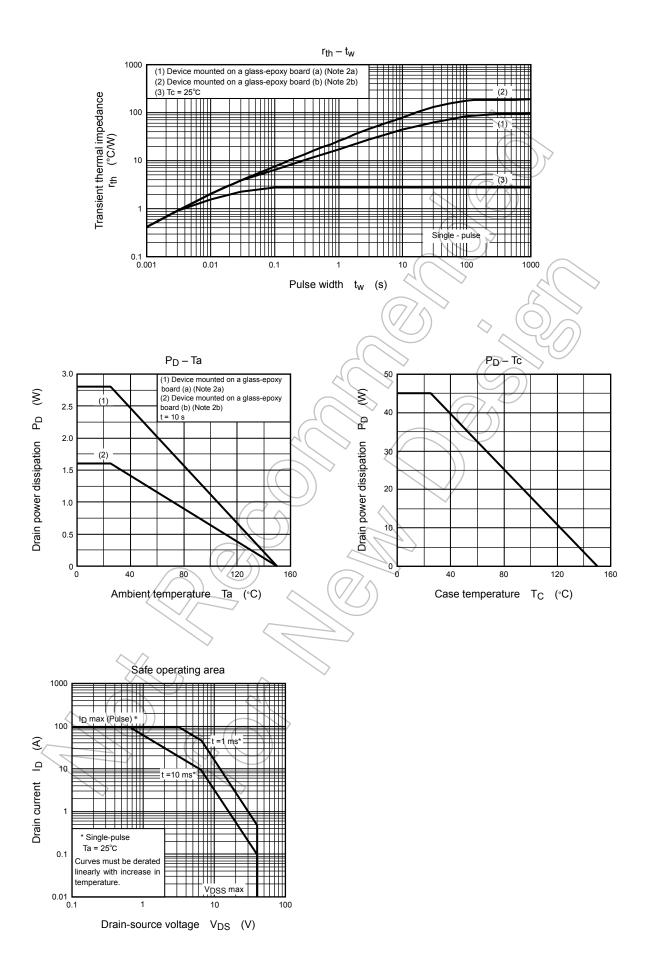








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